

Revision date: 2/27/2023

N109 W13300 ELLSWORTH DRIVE GERMANTOWN, WI 53022 262-253-5900 FAX 262-253-5919

DESCRIPTION:

ResinLab[®] *EP1199 Clear* is a two-part unfilled epoxy adhesive designed for rapid bonding of metals, ceramics and most plastics. It will provide good resistance to water, salt spray, inorganic acids and bases and most organic solvents. *EP1199 Clear* will have improved water and temperature resistance compared to a standard 5-minute epoxy.

EP1199 Clear was formulated to a 1A:1B by volume mix ratio for use in side by side dispensing cartridges or meter/mix and dispense equipment. *EP1199 Clear* will reach handle cure at room temperature within 30-60 minutes and full cure in 24 hours. An elevated cure schedule can be used to achieve final properties quickly. Times and temperatures of 30 minutes at 65 °C to 15 minutes at 100 °C are typical for most applications. Time to heat substrate must be taken into account. Cooler temperatures will also extend work time and increase cure times.

TYPICAL PROPERTIES:

All properties given are at 25 °C unless otherwise noted.

Property:	Value:	Test Method or Source:
Color	Clear	Visual
Mix Ratio	Part A to Part B	Calculated
Mix Ratio by weight	1.19 to 1	
Mix Ratio by volume	1 to 1	
Cure Schedule	24 hrs @ 25 °C	
	30 min @ 65 °C	
	15 min @ 100 °C	
Viscosity - Part A	13,500 cP	Rheometer parallel plate 25mm @ 1/s
Viscosity - Part B	5,000 cP	455300006291
Viscosity - Mixed	9,500 cP	
Specific Gravity - Part A	1.16	Calculated
Specific Gravity - Part B	0.97	
Specific Gravity - Mixed	1.06	
Pot Life defined as the time it takes for	5 minutes	Rheometer parallel plate 25mm @1/s
initial mixed viscosity to double		455300006291
Gel Time 100cc Sample	8 minutes	455300005339/Gardco Gel Timer
Peak Exotherm	150 °C after 9 minutes for 40 mL sample	455300005593 by Type K thermocouple
Hardness	80 Shore D	455300006287/ASTM D2240
Glass Transition Temperature/Tg	44 °C	453560822409 by DSC
Water Absorption	0.15 %	24 hr immersion 457561824543/ASTM D570
Tensile Properties:		4535601224470/ASTM D638
Strength	7,000 psi	
Elongation	4 %	
Modulus	355,000 psi	

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TECHNICAL DATA SHEET EP1199 Clear

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Property:	Value:	Test Method or Source:
Lap Shear Strength		4535601224468/ASTM D1002
0.010" Bond Line, Al to Al	1,100 psi	
Compressive Properties:		4535601224467/ASTM D695
Yield Strength	11,000 psi	
Ultimate Strength	24,000 psi	
Modulus	184,000 psi	
Flame Resistance	Passes with HB Rating @ 6.0 mm	45376013225560/UL94HB
Tested at ResinLab, not UL Certified		
Electrical Resistivity:		455300006612/ASTM D257
Volume	9.1 x 10¹⁵ ohm-cm	@ 22 °C @ 17 %RH
Surface	8.1 x 10 ¹⁵ ohm/sq	
Dielectric Constant & Dissipation Factor	or:	455300006513/ASTM D150
@ 100 Hz	3.0, 0.008	
@ 100 kHz	2.9, 0.008	
Coefficient of Thermal Expansion by TMA:		455300005340/ASTM E831 TMA, 5 °C/min
below Tg	62 ppm/°C	
above Tg	223 ppm/°C	
Operating Temperature Range	-55 to 150 °C**	
Relative Thermal Index (RTI)	90 °C	UL746B, Table 7.1
		Generic Value Based on Composition

* Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

** Operating Temperature Range is based on average design requirements and is not intended as a guarantee of suitability for all applications operating at that temperature.

*** This TDS contains values that have been updated. The values reported in this technical data sheet are typical values of the product, and are highly dependent on test conditions and methodology. We actively seek the most precise and accurate ways to measure and interpret performance of our products, and to update estimated values with measured values. The formula has not been revised or changed in any way. Although the values on paper have changed, you can expect the same performance of the product.

INSTRUCTIONS:

- 1. Bring to room temperature prior to use.
- Cartridge format: Mixer should be attached keeping the cartridge vertical and any air pocket purged this way. After the mixer contains material, the mixer tip can be dropped to dispense pre-bleed amount. Attach a new static mixer with each cartridge, then pre-bleed the first 3 inches of dispensed material or until a uniform color is obtained. Maintain adequate velocity during dispensing to ensure complete mixing.



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- 3. Bulk format: stir until homogeneous weigh and mix parts A and B accurately and thoroughly, scraping sides of container often. Do not pour from mixing container, transfer to a new container as residual unmixed material may cause a tacky spot on the surface of the casting. Maintain adequate velocity during dispensing to ensure complete mixing.
- 4. Clean up uncured resin with suitable organic solvent such as MEK or acetone.
- 5. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.

SHELF LIFE AND STORAGE:

12 months at 25 °C. Specialty packaging may be less.

Many epoxy resin systems are prone to crystallization as epoxy resin is a super-cooled fluid. This condition may give the product a gritty or grainy appearance (or hazy in clear products). Products in this state will not usually cure to normal and expected properties. In extreme cases it may appear solid and cured. Fluctuating temperatures (within 5 to 50 °C) aggravate this phenomenon. Heating the individual component to 50 to 60 °C while stirring can usually restore products to original state. Storage at 25 +/- 10 °C is optimum for most products.